2-2355627-1 <

#### DDR5 DIMM

TE Internal #: 2-2355627-1 Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount, Vertical Module Orientation, DDR5 DIMM, DIMM Sockets

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DRAM Type: Double Data Rate (DDR) 5 Connector System: Board-to-Component Number of Positions: 288 Termination Method to PCB: Surface Mount Module Orientation: Vertical

# Features



### Product Type Features

Connector & Contact Terminates To	Printed Circuit Board	
DRAM Type	Double Data Rate (DDR) 5	
Connector System	Board-to-Component	
Configuration Features		
Number of Keys	1	
Number of Bays	2	
Number of Rows	2	
Number of Positions	288	
Module Orientation	Vertical	
Electrical Characteristics		
DRAM Voltage	1.1 V	
Body Features		
Latch Color	Natural	
Latch Material	High Temperature Nylon	

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PCB Retention Feature Material	Stainless Steel
Connector Profile	Standard
Ejector Material Color	Natural
Module Key Type	DRAM
Ejector Location	Both Ends
Ejector Material	High Temperature Nylon
Ejector Type	Rotary
Contact Features	
Contact Underplating Material	Nickel
Socket Style	DIMM
Contact Mating Area Plating Material Thickness	.76 μm[30 μin]
PCB Contact Termination Area Plating Material Thickness	3 μm[120 μin]
Contact Mating Area Plating Material	Gold (Au)
Memory Socket Type	Memory Card
Contact Base Material	Copper Alloy
PCB Contact Termination Area Plating Material	Tin
Contact Current Rating (Max)	1.5 A



#### **Termination Features**

Direct Insert	
.89 mm[.035 in]	
Surface Mount	
Board Mount	
Vertical	
Tab	
1 Кеу	
With	
None	
Black	
High Temperature Nylon	
.85 mm[.033 in]	

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### Dimensions

Profile Height from PCB	21.3 mm[.083 in]
Row-to-Row Spacing	3 mm[.118 in]
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	High Speed Data
Industry Standards	
UL Flammability Rating	UL 94V-0
Packaging Features	
Packaging Quantity	640
Packaging Method	Box & Tray
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant

China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JAN 2025 (247) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free

Compliant

#### Solder Process Capability

EU ELV Directive 2000/53/EC

Not reviewed for solder process capability

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

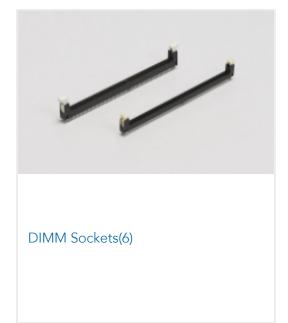
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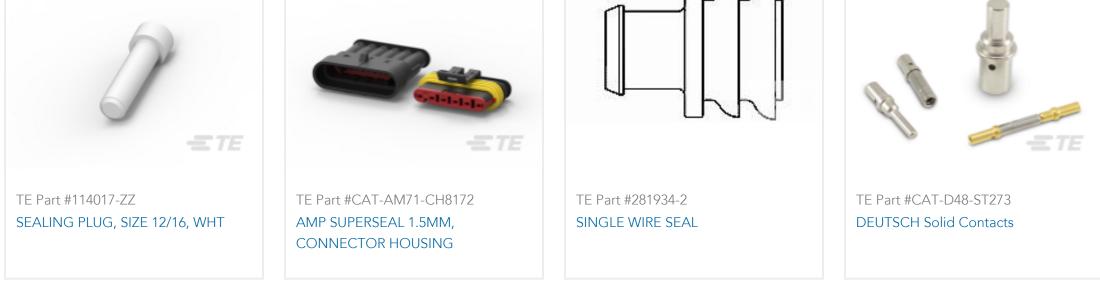
# Compatible Parts



# Also in the Series DDR5 DIMM



# Customers Also Bought





# Documents

Product Drawings DDR5 DIMM BLACK HSG AND NATURAL LATCH

English

Double Data Rate (DDR) 5, Board-to-Component, 288 Position, Surface Mount, Vertical Module Orientation, DDR5 DIMM, DIMM Sockets



**CAD** Files Customer View Model ENG\_CVM\_CVM\_2-2355627-1\_A.3d\_stp.zip English Customer View Model ENG\_CVM\_CVM\_2-2355627-1\_A.3d\_igs.zip English 3D PDF **Customer View Model** ENG\_CVM\_CVM\_2-2355627-1\_A.2d\_dxf.zip

English

3D

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**Product Specifications Application Specification** English